# 281739-4 - ACTIVE

### AMPMODU | AMPMODU HE 13/HE 14

TE Internal #: 281739-4 PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > HE13/HE14 TH Headers, DRST



Connector System: Wire-to-Board

Number of Positions: 8

Number of Rows: 2

Centerline (Pitch): 2.54 mm [.1 in]

PCB Mount Orientation: Vertical

### All HE13/HE14 TH Headers, DRST (20)



## Features

### **Product Type Features**

Connector System	Wire-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	8
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Insulation Resistance	1000 MΩ

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Body Features	
Primary Product Color	Blue
Contact Features	
Contact Mating Area Length	7 mm
Mating Square Post Dimension	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.8 µm[31 µin]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	2.9 mm
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	With
Panel Mount Feature	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Retention	Without
Housing Features	
Housing Material	High Temperature Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	

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Operating Temperature Range	-40 – 100 °C[-40 – 212 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	2000
Packaging Type	Box
Product Compliance For compliance documentation, visit the product page on TE.com>	Compliant
For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
For compliance documentation, visit the product page on TE.com>	Compliant Compliant
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#### Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

Solder Process Capability

Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14





# Also in the Series AMPMODU HE 13/HE 14



# Customers Also Bought





## Documents

## Product Drawings HEADER HE14 STRAIGHT 2X4 P

English

## **CAD** Files

Customer View Model

ENG\_CVM\_CVM\_281739-4\_G.2d\_dxf.zip

PCB Mount Header, Vertical, Wire-to-Board, 8 Position, 2.54 mm [.1 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, AMPMODU HE 13/HE 14



English

3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_281739-4\_G.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_281739-4\_G.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

French

Product Environmental Compliance MD\_281739-4\_021520162330\_dmtec

English

MD\_281739-4\_021520162330\_dmtec

English